



Click here for the 3D model.

| Dimensions | |
|------------|---------------------|
| D | 4mm +/-0.5mm |
| L | 5.4mm +0.25/-0.1mm |
| W | 0.65mm +/-0.1mm |
| F | 0.3mm MAX |
| А | 4.3mm +/-0.2mm |
| В | 4.3mm +/-0.2mm |
| С | 5.5mm MAX |
| E | 1.8mm +/-0.2mm |
| G | 0.35mm +0.15/-0.2mm |
| Р | 1mm +/-0.2mm |
| | |

| Packaging Specifications | | | |
|--------------------------|------------|--|--|
| Packaging | T&R, 380mm | | |
| Packaging Quantity | 2000 | | |

| General Information | | |
|---------------------|--------------------------------------|--|
| Series | EDK | |
| Dielectric | Aluminum Electrolytic | |
| Style | SMD Can | |
| Description | Surface Mount, Aluminum Electrolytic | |
| RoHS | Yes | |
| Lead | V-Chip | |
| Qualifications | AEC-Q200 | |
| AEC-Q200 | Yes | |

| Specifications | |
|-----------------------------|--|
| Capacitance | 22 uF |
| Capacitance Tolerance | 20% |
| Voltage DC | 16 VDC, 20 VDC (Surge) |
| Temperature Range | -40/+85°C |
| Rated Temperature | 85°C |
| Life | 2000 Hrs |
| Dissipation Factor | 26% |
| Ripple Current | 27 mAmps (120Hz), 36.72 mAmps (120Hz 50C) |
| Leakage Current | 3.5 uA (2min 20°C) |
| Impedance Ratio at - 25C | 2 |
| Impedance Ratio at - 40C | 4 |
| High Temperature Solder | Yes |

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